

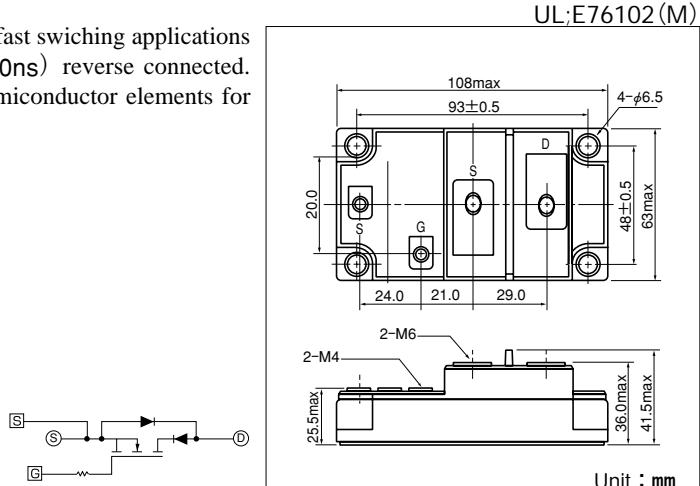
MOSFET MODULE

SF100CB100

SF100CB100 is a isolated power MOSFET module designed for fast switching applications of high voltage and current with a fast recovery diode ($t_{rr} \leq 300\text{ns}$) reverse connected. The mounting base of the module is electrically isolated from semiconductor elements for simple heatsink construction.

- $I_D = 100\text{A}$, $V_{DSS} = 1000\text{V}$
- Suitable for high speed switching applications.
- Low ON resistance.
- Wide Safe Operating Areas.
- $t_{rr} \leq 300\text{ns}$ fast recovery diode for free wheel

(Applications)



($T_j = 25^\circ\text{C}$ unless otherwise specified)

■ Maximum Ratings

| Symbol | Item | Conditions | Ratings | Unit |
|-----------------|----------------------------|-----------------------------------|-------------|-----------------|
| | | | SF100CB100 | |
| V_{DSS} | Drain-Source Voltage | | 1000 | V |
| V_{GSS} | Gate-Source Voltage | | ±30 | V |
| I_D | Drain Current | DC | 100 | A |
| I_{DP} | Current | Pulse | 200 | |
| $-I_D$ | Source Current | | 100 | A |
| P_T | Total Power Dissipation | $T_c = 25^\circ\text{C}$ | 800 | W |
| T_j | Channel Temperature | | -40 to +150 | °C |
| T_{stg} | Storage Temperature | | -40 to +125 | °C |
| V_{iso} | Isolation Voltage (R.M.S.) | A.C. 1minute | 2500 | V |
| Mounting Torque | Mounting (M6) | Recommended Value 2.5-3.9 (25-40) | 4.7 (48) | N·m (kgf·cm) |
| | Terminal (M6) | Recommended Value 2.5-3.9 (25-40) | 4.7 (48) | |
| | Terminal (M4) | Recommended Value 1.0-1.4 (10-14) | 1.5 (15) | |
| Mass | Typical Value | | 460 | g |

■ Electrical Characteristics

($T_j = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Item | Conditions | Ratings | | | Unit |
|---------------|----------------------------------|--|---------|-------|-------|------------------|
| | | | Min. | Typ. | Max. | |
| I_{GSS} | Gate Leakage Current | $V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$ | | | ±0.1 | μA |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{GS} = 0\text{V}$, $V_{DS} = 800\text{V}$ | | | 4.0 | mA |
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | $V_{GS} = 0\text{V}$, $I_D = 1\text{mA}$ | 1000 | | | V |
| $V_{GS(th)}$ | Gate-Source Threshold Voltage | $V_{DS} = V_{GS}$, $I_D = 10\text{mA}$ | 1.5 | | 3.5 | V |
| $R_{DS(on)}$ | Drain-Source On-State Resistance | $I_D = 100\text{A}$, $V_{GS} = 15\text{V}$ | | | 150 | $\text{m}\Omega$ |
| $V_{DS(on)}$ | Drain-Source On-State Voltage | $I_D = 100\text{A}$, $V_{GS} = 15\text{V}$ | | | 15 | V |
| g_{fs} | Forward Transconductance | $V_{DS} = 10\text{A}$, $V_D = 75\text{A}$ | 30 | 50 | | S |
| C_{iss} | Input Capacitance | $V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1.0\text{MHz}$ | | 16000 | 19200 | pF |
| C_{oss} | Output Capacitance | $V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1.0\text{MHz}$ | | 2900 | 4200 | pF |
| $Crss$ | Reverse Transfer Capacitance | $V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1.0\text{MHz}$ | | 1800 | 2600 | pF |
| $td(on)$ | Switching Time | Turn-on Delay Time | | | 150 | ns |
| tr | | Rise Time | | | 300 | |
| $td(off)$ | | Turn-off Delay Time | | | 600 | |
| tf | | Fall Time | | | 300 | |
| V_{SDS} | Diode Forward Voltage | $-I_D = 100\text{A}$, $V_{GS} = 0\text{V}$ | | | 1.8 | V |
| trr | Reverse Recovery Time | $-I_D = 100\text{A}$, $V_{GS} = 15\text{V}$, $di/dt = 400\text{A}/\mu\text{s}$ | | | 300 | ns |
| $R_{th(j-c)}$ | Thermal Resistance | MOSFET | | | 0.16 | °C/W |
| | | Diode | | | 0.64 | |

